74AUP1G06

Low-power inverter with open-drain output Rev. 03 — 15 June 2007

Product data sheet

General description

The 74AUP1G06 provides the single inverting buffer with open-drain output. The output of the device is an open drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through

the device when it is powered down.

2. **Features**

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114E Class 3A exceeds 5000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



74AUP1G06

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3. Ordering information

Table 1. Ordering information

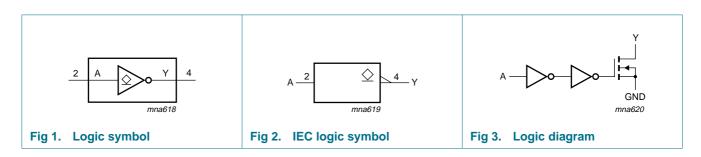
| Type number | Package | | | | | | | | |
|-------------|-------------------|--------|---|----------|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | |
| 74AUP1G06GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 | | | | | |
| 74AUP1G06GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 | | | | | |
| 74AUP1G06GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm | SOT891 | | | | | |

4. Marking

Table 2. Marking

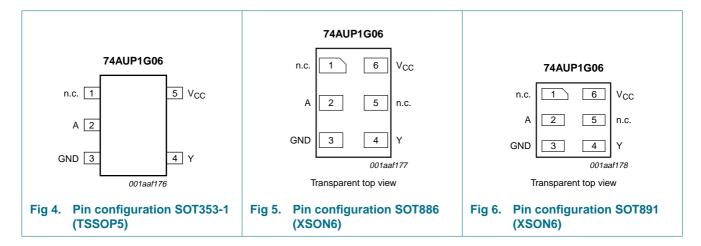
| Type number | Marking code |
|-------------|--------------|
| 74AUP1G06GW | pR |
| 74AUP1G06GM | pR |
| 74AUP1G06GF | pR |

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | | Description |
|-----------------|--------|-------|----------------|
| | TSSOP5 | XSON6 | |
| n.c. | 1 | 1 | not connected |
| A | 2 | 2 | data input |
| GND | 3 | 3 | ground (0 V) |
| Υ | 4 | 4 | data output |
| n.c. | - | 5 | not connected |
| V _{CC} | 5 | 6 | supply voltage |

7. Functional description

Table 4. Function table[1]

| Input | Output |
|-------|--------|
| A | Υ |
| L | Z |
| Н | L |

- [1] H = HIGH voltage level;
 - L = LOW voltage level;
 - Z = high-impedance OFF state.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|-----------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| I_{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| V_{I} | input voltage | | [1] -0.5 | +4.6 | V |
| I_{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0 V$ | - | ±50 | mA |
| V_{O} | output voltage | Active mode and Power-down mode | <u>[1]</u> –0.5 | +4.6 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | +20 | mA |
| I _{CC} | supply current | | - | +50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T_{stg} | storage temperature | | –65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [2] - | 250 | mW |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|--|-----|----------|------|
| V_{CC} | supply voltage | | 0.8 | 3.6 | V |
| V_{I} | input voltage | | 0 | 3.6 | V |
| V_{O} | output voltage | Active mode | 0 | V_{CC} | V |
| | | Power-down mode; V _{CC} = 0 V | 0 | 3.6 | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | 0 | 200 | ns/V |

^[2] For TSSOP5 packages: above 87.5 $^{\circ}$ C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 45 $^{\circ}$ C the value of P_{tot} derates linearly with 2.4 mW/K.

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10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|---|----------------------|-----|----------------------|------|
| T _{amb} = 2 | 5 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.70 \times V_{CC}$ | - | - | ٧ |
| | | V _{CC} = 0.9 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | ٧ |
| | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.30 \times V_{CC}$ | ٧ |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | ٧ |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | ٧ |
| V _{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.3\times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.31 | V |
| | | $I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.31 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.44 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.31 | ٧ |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.44 | ٧ |
| l _l | input leakage current | V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V | - | - | ±0.1 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IL}$; $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.1 | μΑ |
| I _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.2 | μΑ |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.2 | μΑ |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.5 | μΑ |
| ΔI_{CC} | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ | - | - | 40 | μΑ |
| Cı | input capacitance | V_{CC} = 0 V to 3.6 V; V_{I} = GND or V_{CC} | - | 0.8 | - | pF |
| Co | output capacitance | output enabled; $V_O = GND$; $V_{CC} = 0 V$ | - | 1.7 | - | pF |
| | | output disabled; $V_O = GND$; $V_{CC} = 0 V$ | - | 1.1 | - | pF |
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V_{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | $V_{CC} = 0.8 \text{ V}$ | - | - | $0.30 \times V_{CC}$ | ٧ |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|---|----------------------|-----|----------------------|------|
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.3 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.37 | V |
| | | $I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.35 | V |
| | | $I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.33 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.33 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.45 | V |
| I _I | input leakage current | V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V | - | - | ±0.5 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IL}$; $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.5 | μΑ |
| l _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.5 | μΑ |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.6 | μΑ |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.9 | μΑ |
| ΔI_{CC} | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ | - | - | 50 | μΑ |
| T _{amb} = - | 40 °C to +125 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.75 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.25 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.30 \times V_{CC}$ | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.11 | V |
| | | $I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.33 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}$; $V_{CC} = 1.4 \text{ V}$ | - | - | 0.41 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.39 | V |
| | | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.36 | V |
| | | $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.50 | V |
| | | $I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | V |
| | | $I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.50 | V |
| l _l | input leakage current | V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V | - | - | ±0.75 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IL}$; $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.75 | μΑ |
| l _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.75 | μΑ |

 Table 7.
 Static characteristics ...continued

NXP Semiconductors

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|--------------------------------------|---|-----|-----|-------|------|
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | - | - | ±0.75 | μΑ |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 1.4 | μΑ |
| ΔI_{CC} | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ | - | - | 75 | μΑ |

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

| Symbol | Parameter | Conditions | | | 25 °C | | -40 | °C to +12 | 25 °C | Unit |
|---------------------|-------------------|--|-----|-----|--------|------|-----|----------------|-----------------|------|
| | | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| $C_L = 5 p$ | F | | | | | | | | | |
| t _{pd} | propagation delay | A to Y; see Figure 7 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 V$ | | - | 12.8 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 2.3 | 4.3 | 9.9 | 2.0 | 10.9 | 12.0 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 1.8 | 3.1 | 6.1 | 1.5 | 7.1 | 7.8 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.5 | 2.8 | 4.7 | 1.2 | 5.7 | 6.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.2 | 2.2 | 3.2 | 1.0 | 3.9 | 4.3 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.1 | 2.2 | 3.3 | 0.8 | 3.6 | 4.0 | ns |
| C _L = 10 | pF | | | | | | | | | |
| t _{pd} | propagation delay | A to Y; see Figure 7 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 15.8 | - | - | - | - | ns |
| | | V_{CC} = 1.1 V to 1.3 V | | 2.7 | 5.4 | 11.2 | 2.5 | 13.2 | 15.0 | ns |
| | | V_{CC} = 1.4 V to 1.6 V | | 2.2 | 3.9 | 7.0 | 2.0 | 8.5 | 9.4 | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.9 | 3.6 | 5.4 | 1.7 | 6.7 | 7.4 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.7 | 2.9 | 3.8 | 1.4 | 4.5 | 5.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.6 | 3.2 | 4.6 | 1.2 | 4.9 | 5.4 | ns |
| C _L = 15 | pF | | | | | | | | | |
| t _{pd} | propagation delay | A to Y; see Figure 7 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 18.8 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 3.2 | 6.4 | 12.2 | 2.9 | 15.2 | 17.0 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 2.6 | 4.6 | 7.7 | 2.3 | 9.4 | 10.0 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 2.3 | 4.5 | 6.6 | 2.1 | 7.3 | 8.1 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2.1 | 3.5 | 4.6 | 1.7 | 5.1 | 5.7 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 2.0 | 4.0 | 6.0 | 1.5 | 6.5 | 7.2 | ns |

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

| Symbol | Parameter | Conditions | | | 25 °C | | -40 | 0 °C to +125 °C | | Unit |
|-----------------|---------------------|--|-----|-----|--------|------|-----|-----------------|-----------------|------|
| | | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| $C_{L} = 30$ | pF | | | | | | | | | |
| t _{pd} | propagation delay | A to Y; see Figure 7 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 27.8 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 4.4 | 9.3 | 16.5 | 3.9 | 19.3 | 21.3 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 3.6 | 6.8 | 10.1 | 3.2 | 12.0 | 13.2 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 3.2 | 6.8 | 10.7 | 2.9 | 11.0 | 12.1 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2.9 | 5.3 | 7.2 | 2.6 | 7.8 | 8.6 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 2.9 | 6.5 | 10.5 | 2.5 | 10.8 | 11.9 | ns |
| $C_L = 5 p$ | F, 10 pF, 15 pF and | 30 pF | | | | | | | | |
| C_{PD} | power dissipation | $f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ | [3] | | | | | | | |
| | capacitance | $V_{CC} = 0.8 \text{ V}$ | | - | 0.5 | - | - | - | - | pF |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | - | 0.6 | - | - | - | - | pF |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | - | 0.7 | - | - | - | - | pF |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | - | 0.7 | - | - | - | - | pF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 1.0 | - | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | 1.2 | - | - | - | - | pF |

^[1] All typical values are measured at nominal V_{CC}.

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

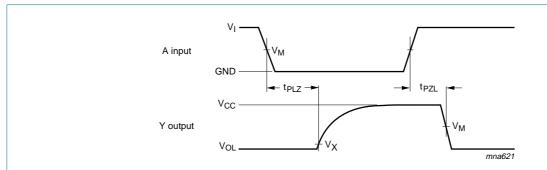
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

^[2] t_{pd} is the same as t_{PZL} and t_{PLZ} .

^[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

Low-power inverter with open-drain output

12. Waveforms



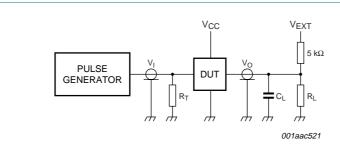
Measurement points are given in Table 9.

Logic level: V_{OL} is the typical output voltage drop that occurs at the output load.

Fig 7. The data input (A) to output (Y) propagation delays

Table 9. Measurement points

| Supply voltage | Input | Output | |
|-----------------|---------------------|---------------------|--------------------------|
| V _{CC} | V _M | V _M | V _X |
| 0.8 V to 1.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{OL} + 0.1 V |
| 1.65 V to 2.7 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{OL} + 0.15 V |
| 3.0 V to 3.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{OL} + 0.3 V |



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 8. Load circuitry for switching times

Table 10. Test data

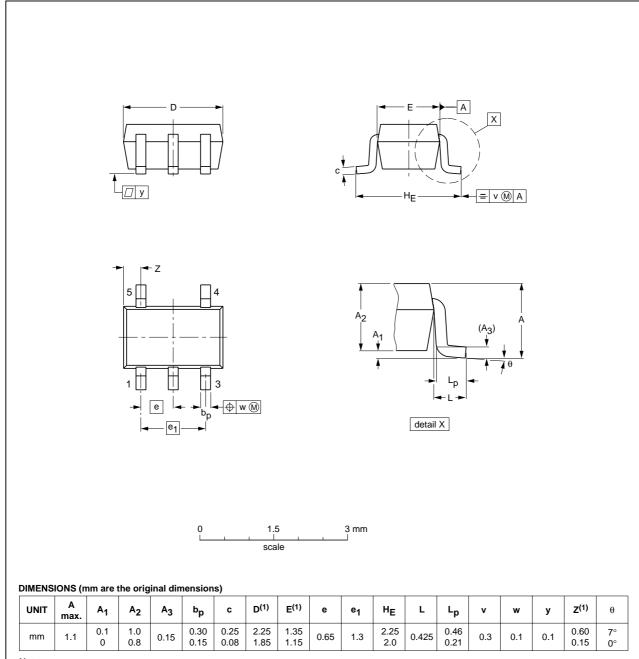
| Supply voltage | Load | | V _{EXT} | | |
|-----------------|------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{CC} | C _L | R _L [1] | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 k Ω or 1 M Ω | open | GND | $2\times V_{CC}$ |

^[1] For measuring enable and disable times $R_L = 5 \text{ k}\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 \text{ M}\Omega$.

13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE | REFERENCES | | | EUROPEAN | ISSUE DATE | |
|----------|------------|--------|--------|----------|------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT353-1 | | MO-203 | SC-88A | | | -00-09-01 03-02-19 |

Fig 9. Package outline SOT353-1 (TSSOP5)

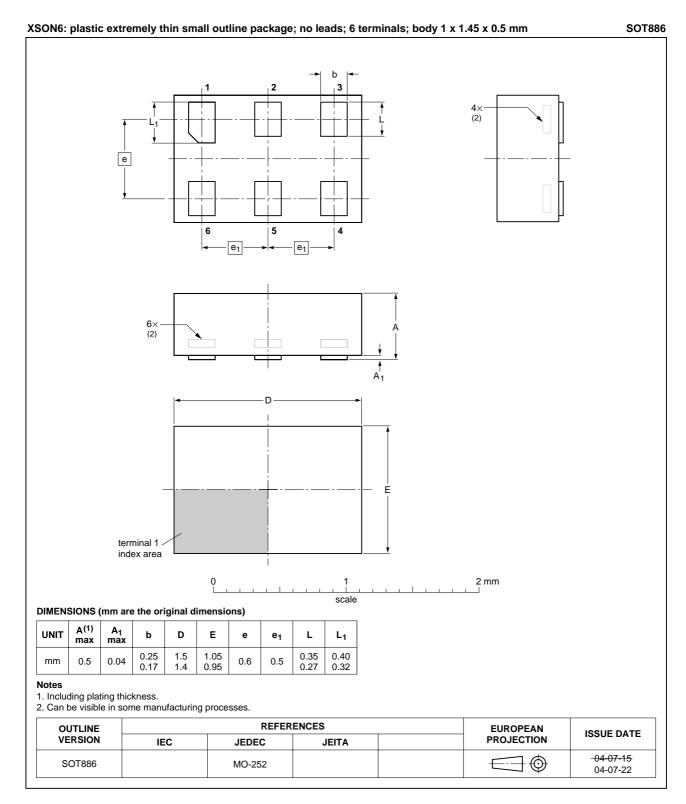


Fig 10. Package outline SOT886 (XSON6)

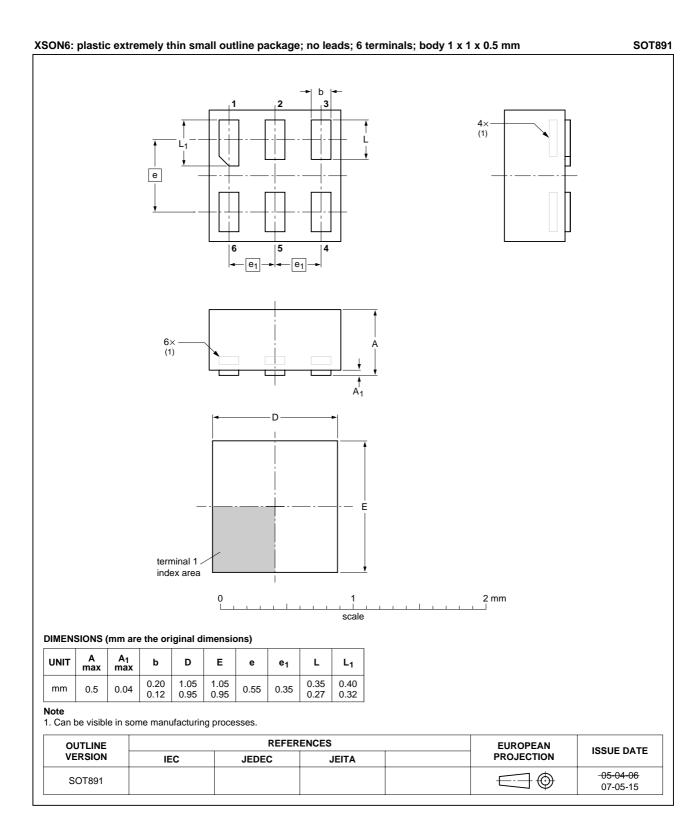


Fig 11. Package outline SOT891 (XSON6)

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14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|-------------------------|
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |

15. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | |
|--|--|---|-----------------------------|----------------------------|--|
| 74AUP1G06_3 | 20070615 | Product data sheet | - | 74AUP1G06_2 | |
| Modifications: | The format of NXP Semicon | of this data sheet has been reconductors. | designed to comply with the | new identity guidelines of | |
| | Legal texts have been adapted to the new company name where appropriate. | | | | |
| | Added I_{OZ} in | Section 10, Table 7 | | | |
| 74AUP1G06_2 | 20060824 | Product data sheet | - | 74AUP1G06_1 | |
| Modifications: | ESD HBM ar | nd C _{PD} values modified in Se | ction 2, Table 8 | | |
| Added type number 74AUP1G06GF (XSON6/SOT891) package | | | | | |
| 74AUP1G06_1 | 20050718 | Product data sheet | - | - | |
| | | | | | |

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16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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